

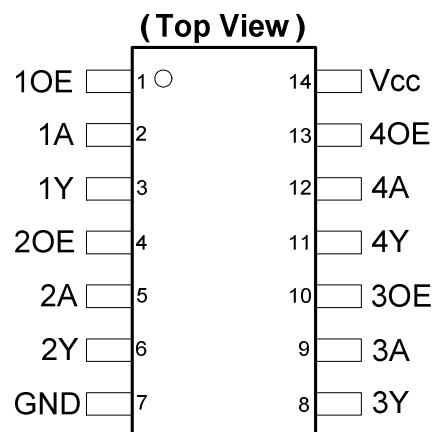
## Description

The 74AHCT126 provides four independent buffer gates with 3-state outputs. Each buffer has a separate enable pin that if driven with a low logic level, places the corresponding output in the high impedance state. The device is designed for operation with a power supply range of 4.5V to 5.5V.

## Features

- Wide Supply Voltage Range from 4.5V to 5.5V
- Inputs Are TTL Voltage Level Compatible
- Outputs Sink or Source 8mA at  $V_{CC} = 4.5V$
- CMOS Low Power Consumption
- Schmitt Trigger Action at All Inputs
- ESD Protection Exceeds JESD 22
  - 200-V Machine Model (A115)
  - 2000-V Human Body Model (A114)
  - Exceeds 1000-V Charged Device Model (C101)
- Latch-Up Exceeds 250mA per JESD 78, Class II
- Range of Package Options SO-14 and TSSOP-14
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

## Pin Assignments



**SO-14 / TSSOP-14**

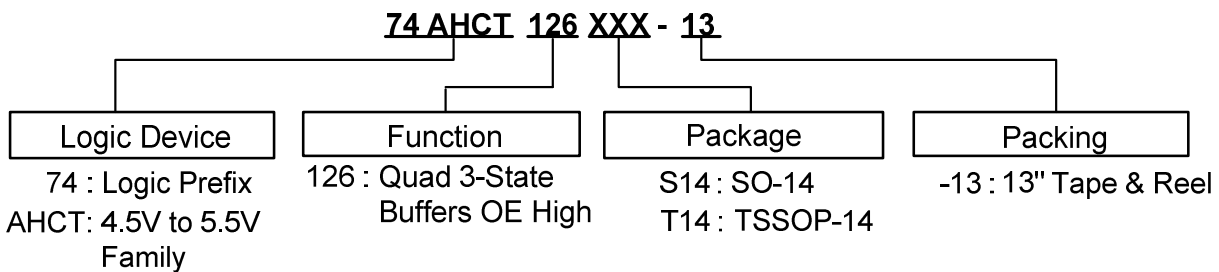
## Applications

- General Purpose Logic
- Wide Array of Products Such as:
  - PCs, Networking, Notebooks, Netbooks
  - Computer Peripherals, Hard Drives, CD/DVD ROMs
  - TVs, DVDs, DVRs, Set Top Boxes

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

## Ordering Information



Part Number	Package Code	Packaging	7" Tape and Reel	
			Quantity	Part Number Suffix
74AHCT126S14-13	S14	SO-14	2,500/Tape & Reel	-13
74AHCT126T14-13	T14	TSSOP-14	2,500/Tape & Reel	-13

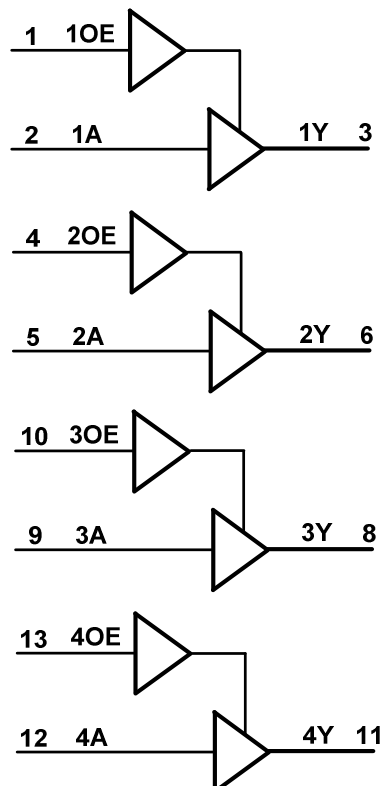
## Pin Descriptions

Pin Number	Pin Name	Function
1	1OE	Data Enable Input (active high)
2	1A	Data Input
3	1Y	Data Output
4	2OE	Data Enable Input (active high)
5	2A	Data Input
6	2Y	Data Output
7	GND	Ground
8	3Y	Data Output
9	3A	Data Input
10	3OE	Data Enable Input (active high)
11	4Y	Data Output
12	4A	Data Input
13	4OE	Data Enable Input (active high)
14	V <sub>CC</sub>	Supply Voltage

## Function Table

Inputs		Output
OE	A	Y
H	H	H
H	L	L
L	X	Z

## Logic Diagram



## Absolute Maximum Ratings (Note 4) ( $T_A = +25^{\circ}\text{C}$ , unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
ESD MM	Machine Model ESD Protection	200	V
$V_{CC}$	Supply Voltage Range	-0.5 to +7.0	V
$V_I$	Input Voltage Range	-0.5 to +7.0	V
$I_{IK}$	Input Clamp Current $V_I < -0.5\text{V}$	-20	mA
$I_{OK}$	Output Clamp Current $V_O < 0\text{V}$	-20	mA
$I_{OK}$	Output Clamp Current $V_O > V_{CC}$	20	mA
$I_O$	Continuous Output Current $0\text{V} < V_O < V_{CC}$	+/- 25	mA
$I_{CC}$	Continuous Current Through $V_{CC}$	50	mA
$I_{GND}$	Continuous Current Through GND	-50	mA
$T_J$	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature	-65 to +150	$^{\circ}\text{C}$
$P_{TOT}$	Total Power Dissipation	500	mW

Note: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

## Recommended Operating Conditions (Note 5) ( $T_A = +25^{\circ}\text{C}$ , unless otherwise specified.)

Symbol	Parameter	Min	Max	Unit
$V_{CC}$	Supply Voltage	4.5	5.5	V
$V_I$	Input Voltage	0	5.5	V
$V_O$	Output Voltage	0	$V_{CC}$	V
$\Delta t/\Delta V$	Input transition Rise or Fall Rate	-	20	ns/V
$T_A$	Operating Free-Air Temperature	-40	+125	$^{\circ}\text{C}$

Note: 5. Unused inputs should be held at  $V_{CC}$  or Ground.

## Electrical Characteristics

Symbol	Parameter	Test Conditions	V <sub>CC</sub>	T <sub>A</sub> = -40°C to +85°C		T <sub>A</sub> = -40°C to +125°C		Unit
				Min	Max	Min	Max	
V <sub>IH</sub>	High-Level Input Voltage	-	4.5V to 5.5V	2.0	-	2.0	-	V
V <sub>IL</sub>	Low-Level Input Voltage	-	4.5V to 5.5V	-	0.8	-	0.8	V
V <sub>OH</sub>	High-Level Output Voltage	I <sub>OH</sub> = -50μA	4.5V	4.4	-	4.4	-	V
		I <sub>OH</sub> = -8mA	4.5V	3.80	-	3.70	-	
V <sub>OL</sub>	Low-Level Output Voltage	I <sub>OL</sub> = 50μA	4.5V	-	0.1	-	0.1	V
		I <sub>OL</sub> = 8mA	4.5V	-	0.44	-	0.55	
I <sub>OZ</sub>	Z State Leakage Current	V <sub>O</sub> = 0 to 5.5V	5.5V	-	±2.5	-	±10	μA
I <sub>I</sub>	Input Current	V <sub>I</sub> = GND to 5.5V	3.6V	-	±1	-	±2	μA
I <sub>CC</sub>	Supply Current	V <sub>I</sub> = GND or V <sub>CC</sub> , I <sub>O</sub> = 0	3.6V	-	20	-	40	μA
ΔI <sub>CC</sub>	Additional Supply Current	One input at V <sub>CC</sub> -2.1V Other pins at V <sub>CC</sub> or GND	5.5V	-	1.35	-	5	mA

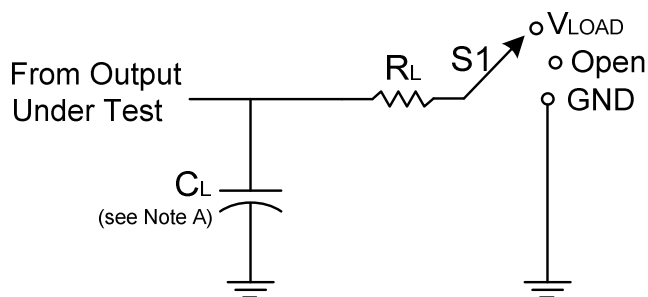
## Operating Characteristics

Parameter		Test Conditions	V <sub>CC</sub> = 5.5V	Unit
			Typ	
C <sub>pd</sub>	Power Dissipation Capacitance per Gate	f = 1MHz	14.8	pF
C <sub>i</sub>	Input Capacitance	V <sub>I</sub> = V <sub>CC</sub> – or GND	4.0	pF

## Switching Characteristics (V<sub>CC</sub> = 4.5V to 5.5V)

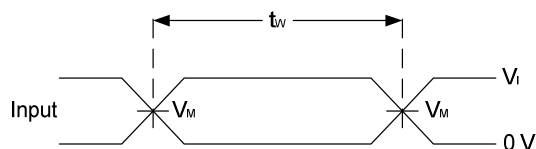
Symbol	Parameter	Test Conditions	T <sub>A</sub> = +25°C			-40°C to +85°C		-40°C to +125°C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
t <sub>PD</sub>	Propagation Delay A <sub>N</sub> to Y <sub>N</sub>	Figure 1 C <sub>L</sub> = 15pF	0.5	3.0	5.5	0.5	6.5	0.5	7.0	ns
		Figure 1 C <sub>L</sub> = 50pF	0.5	4.3	7.5	0.5	8.5	0.5	9.5	
t <sub>EN</sub>	Enable Time $\overline{\text{OE}}_{\text{N}}$ to Y <sub>N</sub>	Figure 1 C <sub>L</sub> = 15 pF	0.5	3.3	5.1	0.5	6.0	0.5	6.5	ns
		Figure 1 C <sub>L</sub> = 50pF	0.5	4.7	7.1	0.5	8.0	0.5	9.0	
t <sub>DIS</sub>	Disable Time $\overline{\text{OE}}_{\text{N}}$ to Y <sub>N</sub>	Figure 1 C <sub>L</sub> = 15pF	0.5	4.8	6.8	0.5	8.0	0.5	8.5	ns
		Figure 1 C <sub>L</sub> = 50pF	0.5	6.5	8.9	0.5	10.0	0.5	11.5	

## Parameter Measurement Information

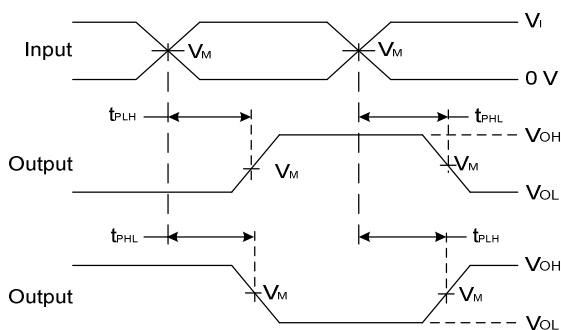


TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	$V_{load}$
$t_{PHZ}/t_{PZH}$	GND

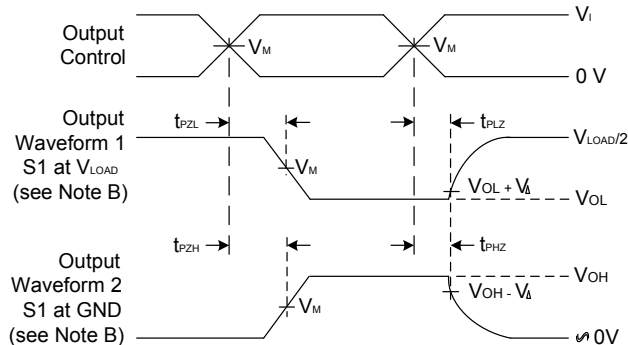
$V_{CC}$	Inputs		$V_M$ Inputs	$V_M$ Outputs	$V_{LOAD}$	$C_L$	$R_L$	$V_{\Delta}$
	$V_I$	$t_r/t_f$						
4.5V to 5.5V	3 V	$\leq 3ns$	1.5 V	$V_{CC}/2$	$V_{CC}$	15pF, 50pF	1K	0.3V



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times  
Inverting and Non Inverting Outputs



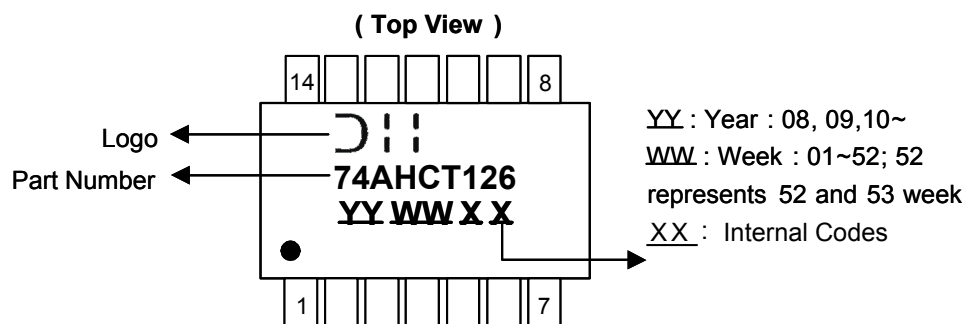
Voltage Waveform Enable and Disable Times  
Low and High Level Enabling

Figure 1. Load Circuit and Voltage Waveforms

- Notes:
- A. Includes test lead and test apparatus capacitance.
  - B. All pulses are supplied at pulse repetition rate  $\leq 1$  MHz.
  - C. Inputs are measured separately one transition per measurement.
  - D.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - E.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{ENO}$ .
  - F.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{PD}$ .

## Marking Information

(1) SO-14, TSSOP-14

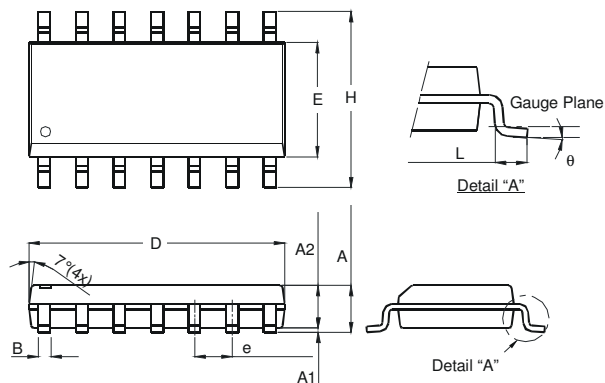


Part Number	Package
74AHCT126S14	SO-14
74AHCT126T14	TSSOP-14

## Package Outline Dimensions (All dimensions in mm.)

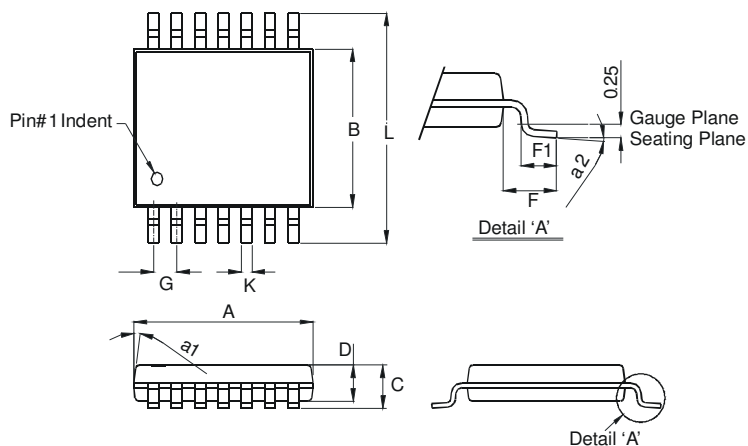
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

### Package Type: SO-14



SO-14		
Dim	Min	Max
A	1.47	1.73
A1	0.10	0.25
A2	1.45 Typ	
B	0.33	0.51
D	8.53	8.74
E	3.80	3.99
e	1.27 Typ	
H	5.80	6.20
L	0.38	1.27
$\theta$	0°	8°
All Dimensions in mm		

### Package Type: TSSOP-14

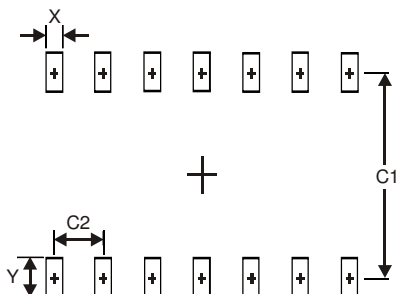


TSSOP-14		
Dim	Min	Max
a1	7° (4X)	
a2	0°	8°
A	4.9	5.10
B	4.30	4.50
C	—	1.2
D	0.8	1.05
F	1.00 Typ	
F1	0.45	0.75
G	0.65 Typ	
K	0.19	0.30
L	6.40 Typ	
All Dimensions in mm		

## Suggested Pad Layout

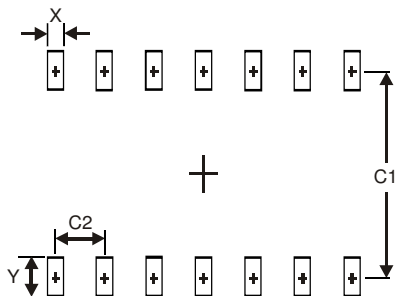
Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.

### Package Type: SO-14



Dimensions	Value (in mm)
X	0.60
Y	1.50
C1	5.4
C2	1.27

### Package Type: TSSOP-14



Dimensions	Value (in mm)
X	0.45
Y	1.45
C1	5.9
C2	0.65



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